SIEMENS

Data sheet

6ES7212-1AF50-0XB0



SIMATIC S7-1200 G2: failsafe compact CPU 1212FC DC/DC/DC; power supply: DC 20.4-28.8 V DC; onboard I/O: 8x DI 24 V DC; 6x DO 24 V DC; memory: program 200 KB data: 500 KB, retentivity: 20 KB

Figure similar

F * 100 CF	
General information	
Product type designation	CPU 1212FC DC/DC/DC
Firmware version	V1.0
FW update possible	Yes
Product function	
I&M data	Yes; I&M0 to I&M3
SysLog	Yes
Engineering with	
 Programming package 	STEP 7 V20 or higher
Supply voltage	
Rated value (DC)	
• 24 V DC	Yes
permissible range, lower limit (DC)	20.4 V
permissible range, upper limit (DC)	28.8 V
Reverse polarity protection	Yes
Input current	
Current consumption (rated value)	125 mA; CPU only
Current consumption, max.	700 mA; CPU with all expansion modules
Inrush current, max.	12 A; at 28.8 V DC
l²t	0.5 A ² ·s
Output current	
for backplane bus (5 V DC), max.	1 000 mA; Max. 5 V DC for SM and CM
Encoder supply	
24 V encoder supply	
• 24 V	Yes; L+ minus 4 V DC min.
 Short-circuit protection 	Yes
 Output current, max. 	300 mA
Power loss	
Power loss, typ.	3 W
Memory	
Work memory	
• integrated	700 kbyte
integrated (for program)	200 kbyte
• integrated (for data)	500 kbyte
Load memory	
• integrated	8 Mbyte
 Plug-in (SIMATIC Memory Card), max. 	32 Gbyte; with SIMATIC memory card
Backup	
• present	Yes

maintenance-free	Yes
without battery	Yes
CPU processing times	
for bit operations, typ.	37 ns; / instruction
for word operations, typ.	30 ns; / instruction
for floating point arithmetic, typ.	74 ns; / instruction
CPU-blocks	74 115, 7 III Structuori
Number of elements (total)	4 000; Blocks (OB, FB, FC, DB) and UDTs
OB	4 000, Blocks (OB, FB, FC, DB) and ODTS
Number of free cycle OBs	100
Number of time alarm OBs	20
Number of delay alarm OBs	20
Number of delay alarm obs Number of cyclic interrupt OBs	20; with minimum OB 3x cycle of 1 ms
Number of cyclic interrupt Obs Number of process alarm OBs	50
Number of process alarm OBs Number of DPV1 alarm OBs	3
Number of isochronous mode OBs	1
Number of startup OBs	100
Number of startup OBs Number of asynchronous error OBs	4
Number of asynchronous error OBs Number of synchronous error OBs	2
Number of synchronous error OBs Number of diagnostic alarm OBs	1
Data areas and their retentivity	
Retentive data area (incl. timers, counters, flags), max.	20 kbyte
Flag	20 NDyto
• Size, max.	8 kbyte; Size of bit memory address area
Local data	5 hoyto, oizo oi vicinomory addicas area
per priority class, max.	64 kbyte; max. 16 KB per block
Address area	of Royle, max. To No per block
Process image	
Inputs, adjustable	1 kbyte
Outputs, adjustable	1 kbyte
Hardware configuration	i ruyte
Hardware configuration	
	6
Number of modules per system, max.	6
Number of modules per system, max. Time of day	6
Number of modules per system, max. Time of day Clock	
Number of modules per system, max. Time of day Clock • Hardware clock (real-time)	Yes
Number of modules per system, max. Time of day Clock Hardware clock (real-time) Backup time	Yes 480 h; Typical
Number of modules per system, max. Time of day Clock Hardware clock (real-time) Backup time Deviation per day, max.	Yes
Number of modules per system, max. Time of day Clock Hardware clock (real-time) Backup time Deviation per day, max. Digital inputs	Yes 480 h; Typical 2 s; at 25 °C
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Number of modules per system, max. Time of day Clock	Yes 480 h; Typical 2 s; at 25 °C 8; Integrated
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Number of modules per system, max. Time of day Clock Hardware clock (real-time) Backup time Deviation per day, max. Digital inputs Number of digital inputs of which inputs usable for technological functions Source/sink input Number of simultaneously controllable inputs all mounting positions — up to 40 °C, max.	Yes 480 h; Typical 2 s; at 25 °C 8; Integrated 8; HSC (High Speed Counting)
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Number of modules per system, max. Time of day Clock Hardware clock (real-time) Backup time Deviation per day, max. Digital inputs Number of digital inputs of which inputs usable for technological functions Source/sink input Number of simultaneously controllable inputs all mounting positions up to 40 °C, max. Input voltage Rated value (DC) for signal "0" for signal "1"	Yes 480 h; Typical 2 s; at 25 °C 8; Integrated 8; HSC (High Speed Counting) Yes 8
Number of modules per system, max. Time of day Clock Hardware clock (real-time) Backup time Deviation per day, max. Digital inputs Number of digital inputs of which inputs usable for technological functions Source/sink input Number of simultaneously controllable inputs all mounting positions — up to 40 °C, max. Input voltage Rated value (DC) for signal "0" for signal "1" Input delay (for rated value of input voltage)	Yes 480 h; Typical 2 s; at 25 °C 8; Integrated 8; HSC (High Speed Counting) Yes 8 24 V 5 V DC or 0.5 mA
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Number of modules per system, max. Time of day Clock Hardware clock (real-time) Backup time Deviation per day, max. Digital inputs Number of digital inputs of which inputs usable for technological functions Source/sink input Number of simultaneously controllable inputs all mounting positions up to 40 °C, max. Input voltage Rated value (DC) for signal "0" for signal "1" Input delay (for rated value of input voltage) for standard inputs parameterizable at "0" to "1", min. at "0" to "1", max. for interrupt inputs parameterizable for technological functions parameterizable for technological functions parameterizable	Yes 480 h; Typical 2 s; at 25 °C 8; Integrated 8; HSC (High Speed Counting) Yes 8 24 V 5 V DC or 0.5 mA 15 V DC at 2.5 mA 0.1 / 0.2 / 0.4 / 0.8 / 1.6 / 3.2 / 6.4 / 10.0 / 12.8 / 20.0 μs; 0.05 / 0.1 / 0.2 / 0.4 / 0.8 / 1.6 / 3.2 / 6.4 / 10.0 / 12.8 / 20.0 ms 0.1 μs 20 ms Yes single phase: 6 HSCs @ 100 kHz & 2 standard @ 30 kHz, quadrature phase: 6

• unshielded, max.	300 m; for technological functions: No
Digital outputs	The technological fariotics is the second of
	6: 20 kHz or 100 kHz
Number of digital outputs	6; 20 kHz or 100 kHz
of which high-speed outputs	4; 100 kHz (Qa.0 - Qa.3)
Limitation of inductive shutdown voltage to	L+ (-40 V)
Switching capacity of the outputs	
 with resistive load, max. 	0.5 A
• on lamp load, max.	5 W
Output voltage	
for signal "0", max.	0.1 V; with 10 kOhm load
• for signal "1", min.	20 V
Output current	
for signal "1" rated value	0.5 A
for signal "0" residual current, max.	10 μΑ
Output delay with resistive load	
● "0" to "1", max.	1 μs; of the pulse outputs (Q a.0 to Q a.3), max. 1.0 μs; of the standard outputs
• "1" to "0", max.	(Qa.4 to Qa.5), max. 50 μs; 3 μs; of the pulse outputs (Q a.0 to Q a.3), max. 3.0 μs; of the standard outputs
	(Qa.4 to Qa.5), max. 200 µs;
Switching frequency	
of the pulse outputs, with resistive load, max.	100 kHz; 100 kHz max. (Qa.0 - Qa.3), 20 kHz max. (Qa.4 - Qa.5)
Relay outputs	
Number of relay outputs	0
Cable length	
shielded, max.	500 m
• unshielded, max.	150 m
Analog inputs	
Number of analog inputs	0
Analog outputs	
Number of analog outputs	0
Encoder	
Connectable encoders	
• 2-wire sensor	Yes
1. Interface	
Interface type	PROFINET
Isolated	Yes
automatic detection of transmission rate	Yes
Autonegotiation	Yes
Autorossing	Yes
Interface types	163
· .	Yes
RJ 45 (Ethernet)Number of ports	2
·	
• integrated switch	Yes
Protocols	Voca IDv4
IP protocol PROFINITI IO Controller	Yes; IPv4
PROFINET IO Controller	Yes
PROFINET IO Device	Yes
SIMATIC communication	Yes
Open IE communication	Yes; Optionally also encrypted
Web server	Yes
Media redundancy	Yes
PROFINET IO Controller	
Transmission rate, max.	100 Mbit/s
Services	
— PG/OP communication	Yes; encryption with TLS V1.3 pre-selected
 Isochronous mode 	Yes
— IRT	Yes
— PROFlenergy	Yes; per user program
— Prioritized startup	Yes
 Number of IO devices with prioritized startup, max. 	16
Number of connectable IO Devices, max.	31
, -	

 Of which IO devices with IRT, max. 	31
 Number of connectable IO Devices for RT, max. 	31
— of which in line, max.	31
 Activation/deactivation of IO Devices 	Yes
 Number of IO Devices that can be simultaneously activated/deactivated, max. 	8
— Updating time	The minimum value of the update time also depends on the communication component set for PROFINET IO, on the number of IO devices and the quantity of configured user data.
Update time for IRT	or configured door data.
— for send cycle of 1 ms	1 ms to 16 ms
— for send cycle of 2 ms	2 ms to 32 ms
— for send cycle of 4 ms	4 ms to 64 ms
Update time for RT	
— for send cycle of 1 ms	1 ms to 512 ms
— for send cycle of 2 ms	2 ms to 512 ms
— for send cycle of 4 ms	4 ms to 512 ms
PROFINET IO Device	11110100121110
Services	
— PG/OP communication	Yes; encryption with TLS V1.3 pre-selected
— Isochronous mode	No
— ISOCITIONOUS Mode — IRT	Yes
— IKI — PROFlenergy	
— PROFlenergy — Shared device	Yes; per user program Yes
Number of IO Controllers with shared device, max. Protocols	2
Supports protocol for PROFINET IO	Yes
PROFIsafe	Yes
PROFIBUS	No
OPC UA	No
AS-Interface	No
Protocols (Ethernet)	110
• TCP/IP	Yes
• DHCP	Yes
• SNMP	Yes
• DCP	Yes
• LLDP	
Number of connections	Yes
Number of connections, max.	400, via integrated interfered of the CDI Land connected CDs / CMs
•	128; via integrated interfaces of the CPU and connected CPs / CMs
Number of connections reserved for ES/HMI/web	10
Number of connections via integrated interfaces	88
Redundancy mode	
Media redundancy	Voca on MDD redundency was a series of the MDD.
— MRP	Yes; as MRP redundancy manager and/or MRP client
— MRPD	Yes
SIMATIC communication	
• S7 routing	No
S7 communication, as server	Yes
07	
S7 communication, as client	Yes
Open IE communication	
Open IE communication ◆ TCP/IP	Yes
Open IE communication ■ TCP/IP — Data length, max.	Yes 8 kbyte
Open IE communication • TCP/IP — Data length, max. — several passive connections per port, supported	Yes
Open IE communication ● TCP/IP — Data length, max.	Yes 8 kbyte
Open IE communication • TCP/IP — Data length, max. — several passive connections per port, supported	Yes 8 kbyte Yes
Open IE communication • TCP/IP — Data length, max. — several passive connections per port, supported • ISO-on-TCP (RFC1006)	Yes 8 kbyte Yes Yes
Open IE communication TCP/IP Data length, max. several passive connections per port, supported ISO-on-TCP (RFC1006) Data length, max.	Yes 8 kbyte Yes Yes 8 kbyte
Open IE communication TCP/IP Data length, max. several passive connections per port, supported ISO-on-TCP (RFC1006) Data length, max. UDP	Yes 8 kbyte Yes Yes 8 kbyte Yes
Open IE communication TCP/IP Data length, max. several passive connections per port, supported ISO-on-TCP (RFC1006) Data length, max. UDP Data length, max.	Yes 8 kbyte Yes Yes 8 kbyte Yes 8 kbyte Yes 2 kbyte; 1 472 bytes for UDP broadcast
Open IE communication TCP/IP Data length, max. several passive connections per port, supported ISO-on-TCP (RFC1006) Data length, max. UDP Data length, max. DHCP	Yes 8 kbyte Yes Yes 8 kbyte Yes 8 kbyte Yes 2 kbyte; 1 472 bytes for UDP broadcast Yes
Open IE communication TCP/IP Data length, max. several passive connections per port, supported ISO-on-TCP (RFC1006) Data length, max. UDP Data length, max. DHCP DNS	Yes 8 kbyte Yes Yes 8 kbyte Yes 8 kbyte Yes 2 kbyte; 1 472 bytes for UDP broadcast Yes Yes

Formulation	Very Ontional
Encryption	Yes; Optional
Web server	
• supported	Yes
• HTTPS	Yes
• web API	Yes
Number of sessions, max.	30
User-defined websites	Yes
Further protocols	
• MODBUS	Yes
communication functions / header	
S7 communication	
supported	Yes
• as server	Yes
• as client	Yes
User data per job, max.	See online help (S7 communication, user data size)
Number of connections	See Online help (37 confindincation, user data size)
	DO Commention of American HIMI Commentions American 4 (00 months)
• overall	PG Connections: 4 reserved; HMI Connections: 4 reserved / 82 max; S7 Connections: 78 max; Open User Connections: 78 max; Web Connections: 2 reserved / 80 max; Total Connections: 10 reserved / 88 max
S7 message functions	
Number of login stations for message functions, max.	32
Program alarms	Yes
Number of configurable program messages, max.	5 000
Number of loadable program messages in RUN, max.	2 500
Test commissioning functions	2 000
Status/control	V.
Status/control variable	Yes
Variables	Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters
Forcing	
Forcing	Yes
Diagnostic buffer	
• present	Yes
Traces	
 Number of configurable Traces 	4
 Memory size per trace, max. 	512 kbyte
Interrupts/diagnostics/status information	
Diagnostics indication LED	
RUN/STOP LED	Yes
• ERROR LED	Yes
• MAINT LED	Yes
Supported technology objects	
Motion Control	Yes
 Number of available Motion Control resources for technology objects 	800
 Number of available Extended Motion Control resources for technology objects 	40
Integrated Functions	
Counter	Yes
 Number of counters 	8
Counting frequency, max.	100 kHz; la.0 to la.5: 100 kHz (80 kHz in quadrature mode), la.6 to la.7: 30 kHz (20 kHz in quadrature mode)
Frequency measurement	Yes
PID controller	Yes
Number of pulse outputs	8; individually assigned to CPU and Signal Board
Limit frequency (pulse)	100 kHz
Potential separation	
Potential separation digital inputs	
· · · · · · · · · · · · · · · · · · ·	Vest field side to logic: 707 V DC (type test)
 Potential separation digital inputs 	Yes; field side to logic: 707 V DC (type test)
- bahusan tha aba:l-	
between the channels	No
Number of potential groups	1

• hotwoon the channels	No
between the channels Number of potential groups	No 1
Number of potential groups EMC	'
Interference immunity against discharge of static electricity • Interference immunity against discharge of static	Yes
electricity acc. to IEC 61000-4-2	Tes
 Test voltage at air discharge 	8 kV
Test voltage at contact discharge	6 kV
Interference immunity to cable-borne interference	
 Interference immunity on supply lines acc. to IEC 61000- 4-4 	Yes
 Interference immunity on signal cables acc. to IEC 61000- 4-4 	Yes
Interference immunity against voltage surge	
 Interference immunity on supply lines acc. to IEC 61000- 4-5 	Yes
Interference immunity against conducted variable disturbance indu	ced by high-frequency fields
Interference immunity against high-frequency radiation	Yes
acc. to IEC 61000-4-6	
Emission of radio interference acc. to EN 55 011	
 Limit class A, for use in industrial areas 	Yes; Group 1
• Limit class B, for use in residential areas	Yes; When appropriate measures are used to ensure compliance with the limits for Class B according to EN 55011
Degree and class of protection	
IP degree of protection	IP20
Standards, approvals, certificates	
CE mark	Yes
UL approval	Yes
cULus	Yes
FM approval	No
RCM (formerly C-TICK)	Yes
KC approval	No
Marine approval	No
Highest safety class achievable in safety mode	
Performance level according to ISO 13849-1	PLe
SIL acc. to IEC 61508	SIL 3
Probability of failure (for service life of 20 years and repair time	e of 100 hours)
 Low demand mode: PFDavg in accordance with 	< 2.00E-05
OIL3	
SIL3 — High demand/continuous mode: PFH in accordance	< 1.00E-09 up to an operational altitude of 3 000 m or < 2.00E-09 at an
High demand/continuous mode: PFH in accordance with SIL3	< 1.00E-09 up to an operational altitude of 3 000 m or < 2.00E-09 at an operating altitude greater than 3 000 m up to 5 000 m
High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header	operating altitude greater than 3 000 m up to 5 000 m
High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update	operating altitude greater than 3 000 m up to 5 000 m Yes
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot	operating altitude greater than 3 000 m up to 5 000 m Yes Yes
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data	operating altitude greater than 3 000 m up to 5 000 m Yes
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions	operating altitude greater than 3 000 m up to 5 000 m Yes Yes
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall	Yes Yes No
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall Fall height, max.	operating altitude greater than 3 000 m up to 5 000 m Yes Yes
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall	yes Yes No 0.3 m; five times, in product package
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall Fall height, max.	Yes Yes No
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall Fall height, max. Ambient temperature during operation	yes Yes No 0.3 m; five times, in product package
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall Fall height, max. Ambient temperature during operation min.	Yes Yes No 0.3 m; five times, in product package
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall • Fall height, max. Ambient temperature during operation • min. • max.	yes Yes No 0.3 m; five times, in product package -20 °C; No condensation 40 °C; at max. voltages and max. specifications -20 °C; No condensation 60 °C; at rated voltages, 50 % of max. specification and alternate IO active
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall Fall height, max. Ambient temperature during operation min. max. horizontal installation, min.	yes Yes No 0.3 m; five times, in product package -20 °C; No condensation 40 °C; at max. voltages and max. specifications -20 °C; No condensation
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall Fall height, max. Ambient temperature during operation min. max. horizontal installation, min. horizontal installation, max.	yes Yes No 0.3 m; five times, in product package -20 °C; No condensation 40 °C; at max. voltages and max. specifications -20 °C; No condensation 60 °C; at rated voltages, 50 % of max. specification and alternate IO active
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall • Fall height, max. Ambient temperature during operation • min. • max. • horizontal installation, min. • horizontal installation, max. • vertical installation, min.	yes Yes No 0.3 m; five times, in product package -20 °C; No condensation 40 °C; at max. voltages and max. specifications -20 °C; No condensation 60 °C; at rated voltages, 50 % of max. specification and alternate IO active -20 °C; No condensation
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall • Fall height, max. Ambient temperature during operation • min. • max. • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max.	yes Yes No 0.3 m; five times, in product package -20 °C; No condensation 40 °C; at max. voltages and max. specifications -20 °C; No condensation 60 °C; at rated voltages, 50 % of max. specification and alternate IO active -20 °C; No condensation
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall • Fall height, max. Ambient temperature during operation • min. • max. • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Ambient temperature during storage/transportation	Yes Yes No 0.3 m; five times, in product package -20 °C; No condensation 40 °C; at max. voltages and max. specifications -20 °C; No condensation 60 °C; at rated voltages, 50 % of max. specification and alternate IO active -20 °C; No condensation 50 °C; at rated voltages, 50 % of max. specification and alternate IO active
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall Fall height, max. Ambient temperature during operation min. max. horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min.	Yes Yes No 0.3 m; five times, in product package -20 °C; No condensation 40 °C; at max. voltages and max. specifications -20 °C; No condensation 60 °C; at rated voltages, 50 % of max. specification and alternate IO active -20 °C; No condensation 50 °C; at rated voltages, 50 % of max. specification and alternate IO active -40 °C
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall Fall height, max. Ambient temperature during operation min. max. horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. min. vertical installation, max. min. max. Ambient temperature during storage/transportation min. max.	Yes Yes No 0.3 m; five times, in product package -20 °C; No condensation 40 °C; at max. voltages and max. specifications -20 °C; No condensation 60 °C; at rated voltages, 50 % of max. specification and alternate IO active -20 °C; No condensation 50 °C; at rated voltages, 50 % of max. specification and alternate IO active -40 °C
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall • Fall height, max. Ambient temperature during operation • min. • max. • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Ambient temperature during storage/transportation • min. • max. Ambient temperature during storage/transportation • min. • max. Air pressure acc. to IEC 60068-2-13	yes Yes No 0.3 m; five times, in product package -20 °C; No condensation 40 °C; at max. voltages and max. specifications -20 °C; No condensation 60 °C; at rated voltages, 50 % of max. specification and alternate IO active -20 °C; No condensation 50 °C; at rated voltages, 50 % of max. specification and alternate IO active -40 °C 70 °C
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall • Fall height, max. Ambient temperature during operation • min. • max. • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Ambient temperature during storage/transportation • min. • max. Air pressure acc. to IEC 60068-2-13 • Operation, min.	yes Yes No 0.3 m; five times, in product package -20 °C; No condensation 40 °C; at max. voltages and max. specifications -20 °C; No condensation 60 °C; at rated voltages, 50 % of max. specification and alternate IO active -20 °C; No condensation 50 °C; at rated voltages, 50 % of max. specification and alternate IO active -40 °C 70 °C
— High demand/continuous mode: PFH in accordance with SIL3 product functions / security / header signed firmware update Secure Boot safely removing data Ambient conditions Free fall • Fall height, max. Ambient temperature during operation • min. • max. • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Ambient temperature during storage/transportation • min. • max. Ambient temperature during storage/transportation • min. • max. Air pressure acc. to IEC 60068-2-13 • Operation, min. • Operation, max.	Yes Yes No 0.3 m; five times, in product package -20 °C; No condensation 40 °C; at max. voltages and max. specifications -20 °C; No condensation 60 °C; at rated voltages, 50 % of max. specification and alternate IO active -20 °C; No condensation 50 °C; at rated voltages, 50 % of max. specification and alternate IO active -40 °C 70 °C 540 hPa 1 140 hPa

Although the state of the state	
Altitude during operation relating to sea level	4000
Installation altitude, min.	-1 000 m
Installation altitude, max.	5 000 m; Restrictions for installation altitudes > 2 000 m, see manual
Relative humidity	
Operation, max.	95 %; no condensation
Vibrations	
 Vibration resistance during operation acc. to IEC 60068- 2-6 	3.5 mm from 5 - 8.4 Hz, 1g from 8.4 - 150 Hz
Operation, tested according to IEC 60068-2-6	Yes
Shock testing	
tested according to IEC 60068-2-27	Yes; IEC 68, Part 2-27 half-sine: strength of the shock 15 g (peak value), duration 11 ms
Pollutant concentrations	
 SO2 at RH < 60% without condensation 	S02: < 0.5 ppm; H2S: < 0.1 ppm; RH < 60% condensation-free
configuration / header	
configuration / programming / header	
Programming language	
— LAD	Yes; incl. failsafe
— FBD	Yes; incl. failsafe
— SCL	Yes
Know-how protection	
 User program protection/password protection 	Yes
Access protection	
 protection of confidential configuration data 	Yes
 Protection level: Write protection 	Yes
 Protection level: Read/write protection 	Yes
 Protection level: Write protection for Failsafe 	Yes
 Protection level: Complete protection 	Yes
 User administration 	Yes; device-wide
Number of users	100
Number of groups	100
 Number of roles 	50
programming / cycle time monitoring / header	
adjustable	Yes
Dimensions	
Width	70 mm
Height	125 mm
Depth	100 mm
Weights	
Weight, approx.	319 g
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last modified:

1/22/2025